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## FDN86501LZ N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

**60 V, 2.6 A, 116 m**Ω

#### Features

- Shielded Gate MOSFET Technology
- Max r<sub>DS(on)</sub> = 116 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 2.6 A
- Max r<sub>DS(on)</sub> = 173 mΩ at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 2.1 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL tested
- RoHS Compliant

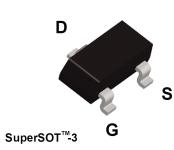


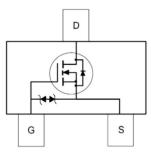
## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for  $r_{DS(on)}$ , switching performance and ruggedness.

### Applications

- Primary DC-DC Switch
- Load Switch





#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted.

Symbol	Parameter	Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage		60	V	
V <sub>GS</sub>	Gate to Source Voltage		±20	V	
•	-Continuous	(Note 1a)	2.6	•	
I <sub>D</sub>	-Pulsed	(Note 4)	24	— A	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	6	mJ	
	Power Dissipation	(Note 1a)	1.5		
PD	Power Dissipation	(Note 1b)	0.6		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C	

#### **Thermal Characteristics**

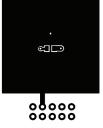
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	80	C/VV

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
8650	FDN86501LZ	SSOT-3	7 "	8 mm	3000 units

FDN86501LZ 1	
N-Ch	
Shielded (	
annel Shielded Gate PowerTrench <sup>®</sup>	
rench <sup>®</sup> MOSFET	
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Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		68		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V			±10	μA
On Chara	Acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.0	1.9	2.4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-5		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.6 A		89	116	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 2.1 A		121	173	mΩ
· · /		$V_{GS}$ = 10 V, I <sub>D</sub> = 2.6 A, T <sub>J</sub> = 125 °C		152	198	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.6 A		8		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance	— V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, — f = 1 MHz		236	335	pF
C <sub>oss</sub>	Output Capacitance			77	110	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			4.9	10	pF
R <sub>g</sub>	Gate Resistance		0.1	0.8	2.0	Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			4.4	10	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 2.6 A,		1.2	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		9.6	20	ns
t <sub>f</sub>	Fall Time			1.2	10	ns
Qg	Total Gate Charge	$V_{GS}$ = 0 V to 10 V		3.8	5.4	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 30 V,$		1.9	2.7	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 2.6 A		0.7		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			0.6		nC
Drain-So	urce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2.6 A (Note 2)		0.9	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	—I <sub>F</sub> = 2.6 A, di/dt = 100 A/μs		31	50	ns
Q <sub>rr</sub>	Reverse Recovery Charge	- 2.0 Λ, αναι - 100 Λ/μδ		19	31	nC



2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

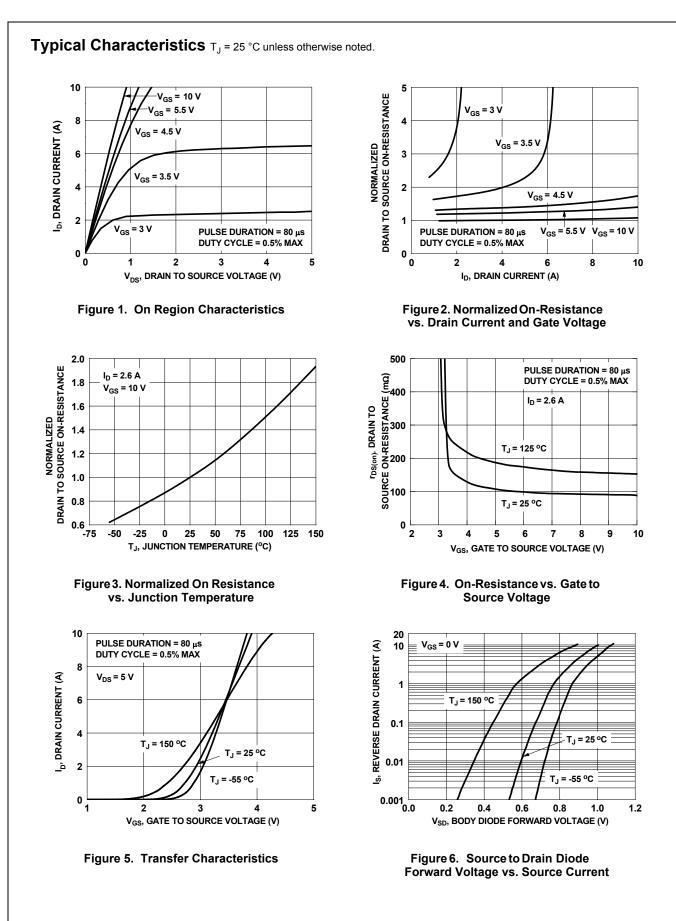
4. Pulsed Id please refer to Fig 11 SOA graph for more details.

a) 80 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

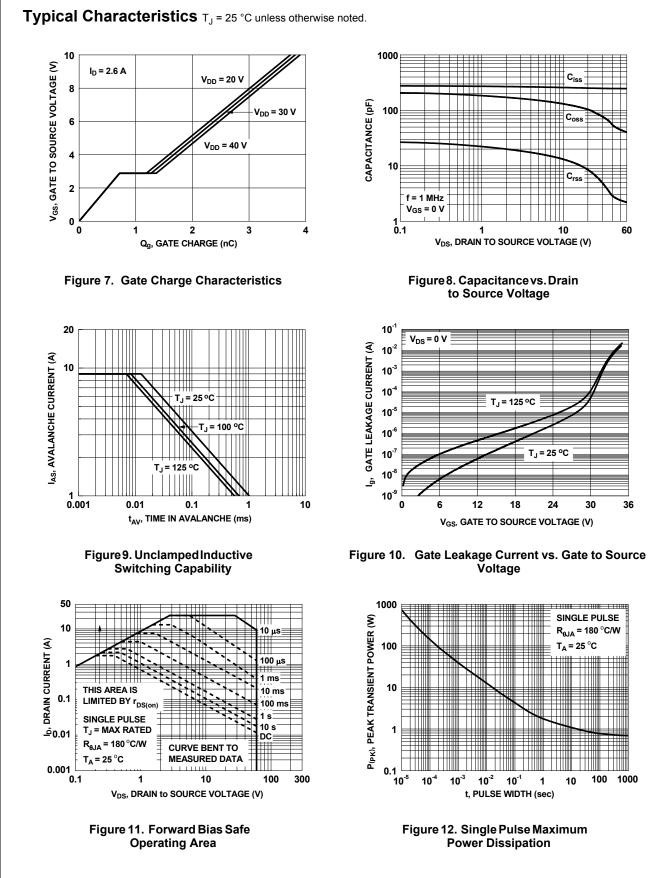
3.  $E_{AS}$  of 6 mJ is based on starting  $T_J$  = 25 °C, L = 3 mH,  $I_{AS}$  = 2 A,  $V_{DD}$  = 60 V,  $V_{GS}$  = 10 V. 100% test at L = 0.1 mH,  $I_{AS}$  = 9 A.



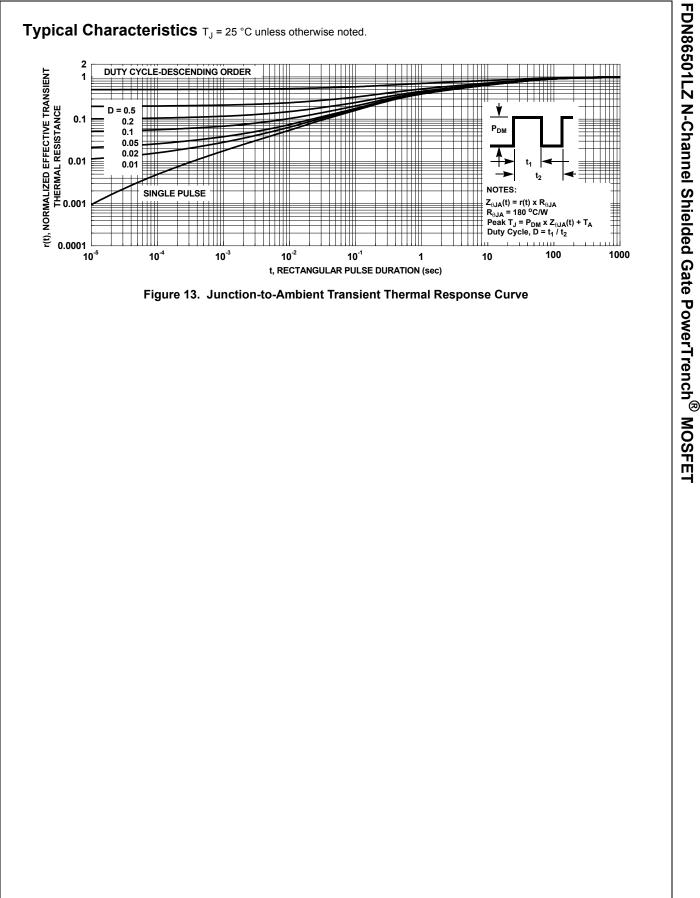
b) 180 °C/W when mounted on a minimum pad.

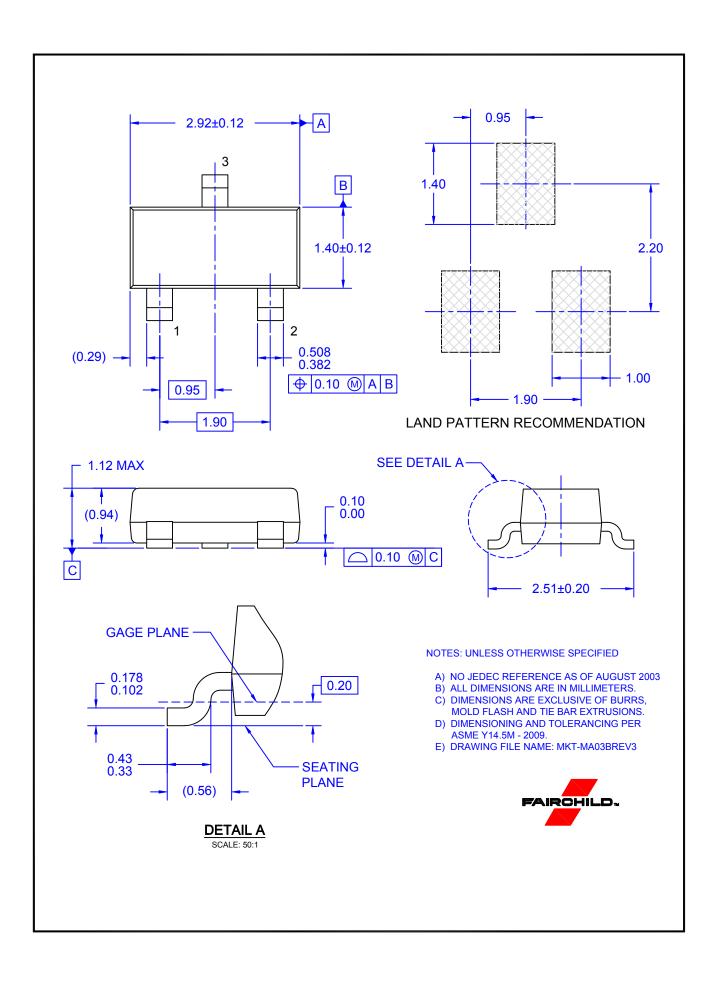


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FDN86501LZ N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET





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